



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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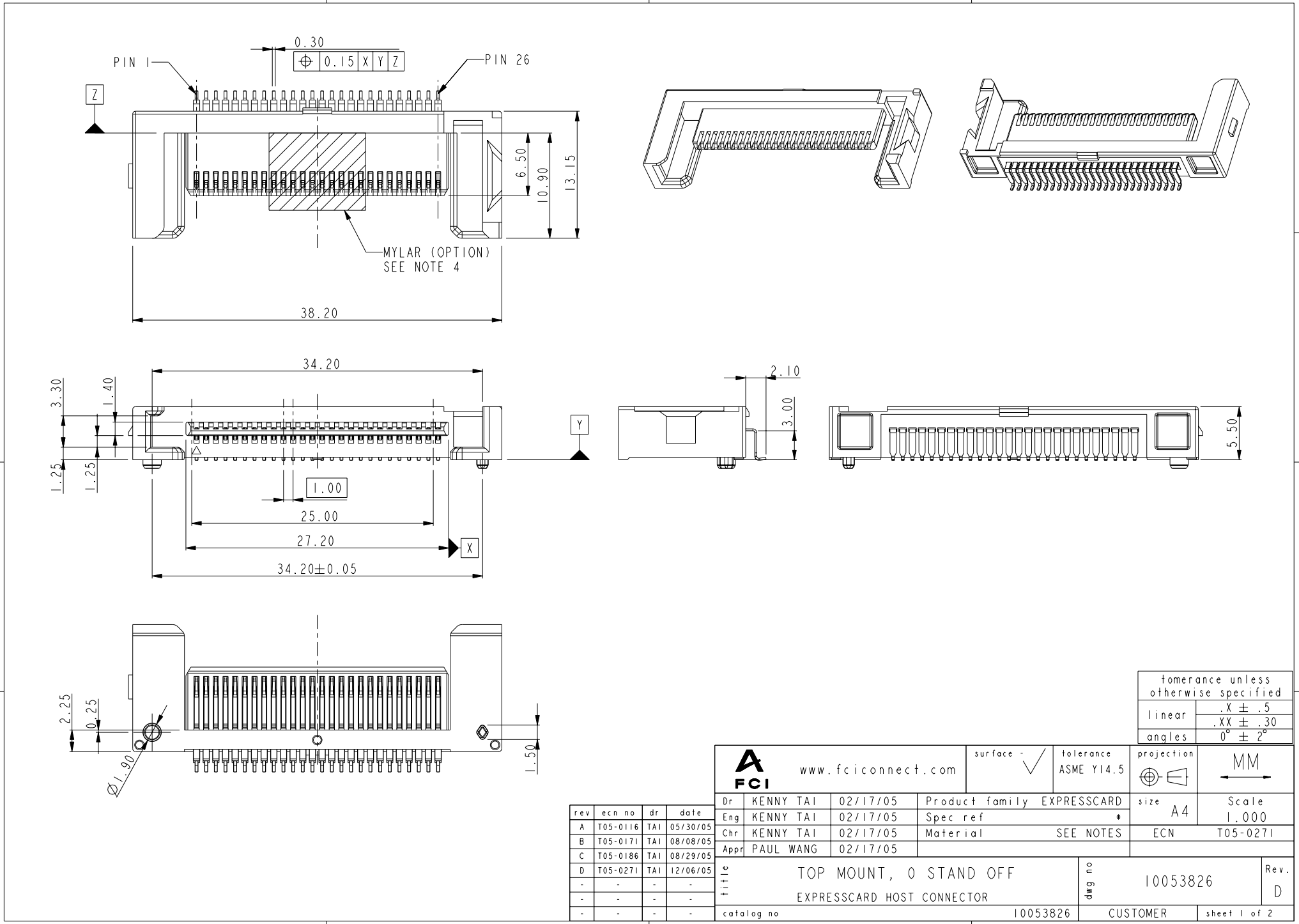
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



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rev	ecn no	dr	date
A	T05-0116	TAI	05/30/05
B	T05-0171	TAI	08/08/05
C	T05-0186	TAI	08/29/05
D	T05-0271	TAI	12/06/05
-	-	-	-
-	-	-	-
-	-	-	-

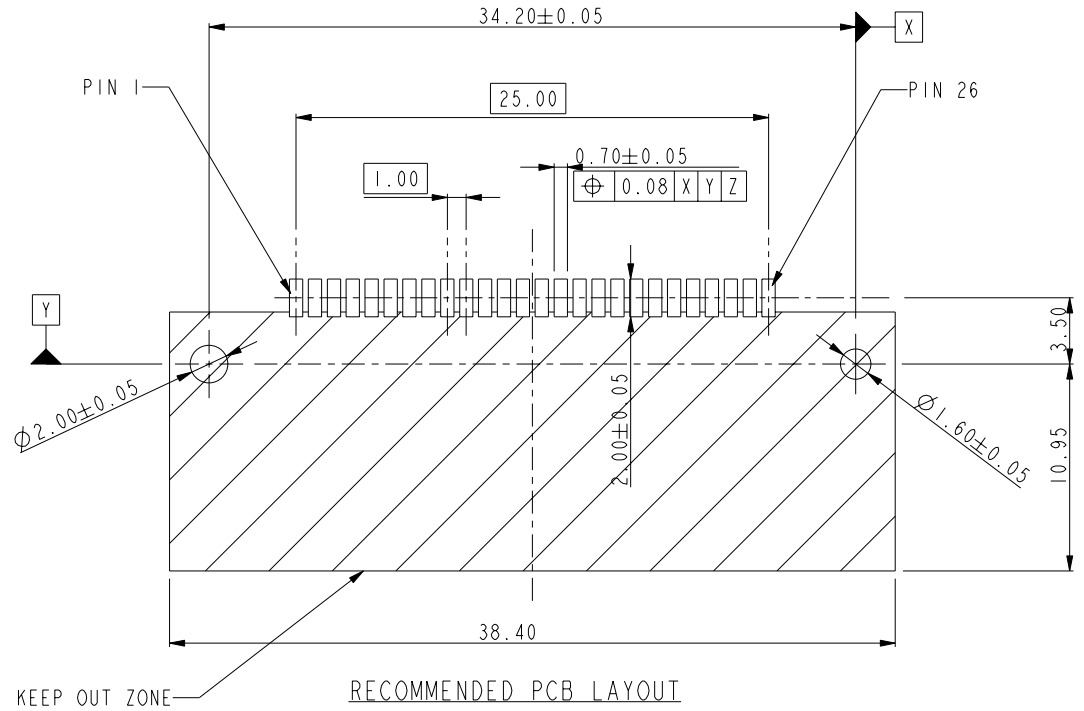
FCI www.fciconnect.com		surface <input checked="" type="checkbox"/>	tolerance ASME Y14.5	projection \oplus	MM
Dr	KENNY TAI	02/17/05	Product family	EXPRESSCARD	size A4
Eng	KENNY TAI	02/17/05	Spec ref	*	Scale 1.000
Chr	KENNY TAI	02/17/05	Material	SEE NOTES	ECN T05-0271
Appr	PAUL WANG	02/17/05			
title TOP MOUNT, 0 STAND OFF			dwg no 10053826		Rev. D
title EXPRESSCARD HOST CONNECTOR			catalog no 10053826		CUSTOMER sheet 1 of 2

tolerance unless otherwise specified	
linear	.X ± .5
	.XX ± .30
angles	0° ± 2°

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NOTES :

1. MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC,
UL 94 V-0 FLAME RETARDANT.
TERMINAL: COPPER ALLOY.
PLATING SPEC. AS BELOW :
Ni 50u" UNDER PLATED.
Au OR GXT 30u" OVER CONTACT AREA. (ONE SIDE)
Tin 120u" OVER SOLDERING AREA.
2. PACKING SPEC. GS-14-924.
3. PRODUCT PERFORMANCE PER SPEC. GS-12-285.
4. PART NUMBER SCHEME: (EX. 10053826-100ABSMFLF)
10053826-X XX X X X X LF (LEAD FREE)

SPEC.	OPTION (CODE)		
MYLAR	WITH (M)	WITHOUT ()	
PACKING	TRAY (S)	TAPE & REEL (T)	TUBE (P)
HSG COLOR	BLACK (B)	NATURE (N)	
MOUNT SIDE	ABOVE (A)		
STAND-OFF	0 (00)		
PLATING	GOLD (I)	GXT (2)	

5. RoHS COMPATIBLE PRODUCT SPECIFICATIONS

- a-PLATING:
- "LF" MEANS THE PRODUCT IS LEAD-FREE, 2micro-meter MINIMUM MATTE TIN OVER 1.27micro-meter MINIMUM NICKEL UNDERPLATE.
b-MANUFACTURING PROCESS COMPATIBILITY.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A REFLOW SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.

title	TOP MOUNT, 0 STAND OFF EXPRESSCARD HOST CONNECTOR	dwg no	10053826	Rev.	D
catalog no	10053826	CUSTOMER		sheet 2 of 2	